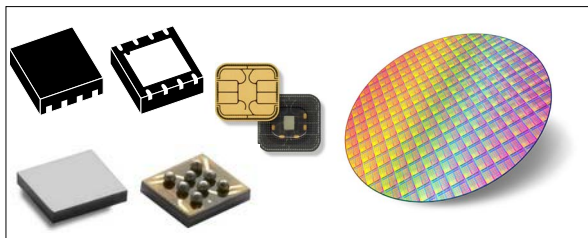




ST33G1M2, ST33G1M0, ST33G896, ST33G768, ST33G640, ST33G512

Secure MCU with 32-bit ARM® SecurCore® SC300™ CPU, SWP, ISO, SPI and GPIO interfaces and high-density Flash memory

Data brief



Features

Hardware features

- ARM® SecurCore® SC300™ 32-bit RISC core cadenced at 25 MHz
- 30 Kbytes of user RAM
- Up to 1280 Kbytes of user Flash memory with OTP area
- Asynchronous receiver transmitter supporting ISO/IEC 7816-3 T=0 and T=1 protocols (Slave mode supported)
- Single wire protocol (SWP) interface for communications with NFC router (ETSI 102-613 compliant)
- Master/slave serial peripheral interface (SPI)
- Three 16-bit timers with interrupt capability
- Seven general-purpose I/Os enabling proprietary protocol implementation
- 1.8 V, 3 V and 5 V supply voltage ranges
- External clock frequency from 1 up to 10 MHz
- Current consumption compatible with GSM and ETSI specifications
- Power-saving standby state
- Contact assignment compatible with ISO/IEC 7816-2
- ESD protection greater than 4 kV (HBM)

- Delivery forms:
 - D18 micromodules
 - Sawn 12" wafers
 - ECOPACK®-compliant WLCSP, DFN8 5 × 6 mm and UDFN8 4.2 × 4 mm packages

Software features

- Secure Flash memory loader
- Flash memory drivers

Security features

- Active shield
- Memory protection unit (MPU)
- Monitoring of environmental parameters
- Protection against faults
- 16- and 32-bit CRC calculation block (ISO 13239, IEEE 802.3, etc.)
- True random number generator
- Unique serial number on each die
- Hardware security-enhanced DES accelerator
- Hardware security-enhanced AES accelerator
- NESCRYPT coprocessor for public key cryptography algorithm

Applications

Major applications include:

- Mobile communications (GSM, 3G and CDMA)
- NFC mobile transactions
- Java Card™ applications
- Multimedia

1 Description

The device is a serial access microcontroller designed for secure mobile applications. It incorporates the most recent generation of ARM® processors for embedded secure systems. Its SecurCore® SC300™ 32-bit RISC core is built on the Cortex® M3 core with additional security features to help to protect against advanced forms of attacks.

The SC300™ core brings great performance and excellent code density thanks to the Thumb®-2 instruction set.

The high-speed embedded Flash memory introduces more flexibility to the system.

The device also offers a serial communication interface fully compatible with the ISO/IEC 7816-3 standard (T=0, T=1) and a single-wire protocol (SWP) interface for communication with a near field communication (NFC) router in SIM/NFC applications.

An SPI Master/Slave interface is also available for communication in non-SIM applications.

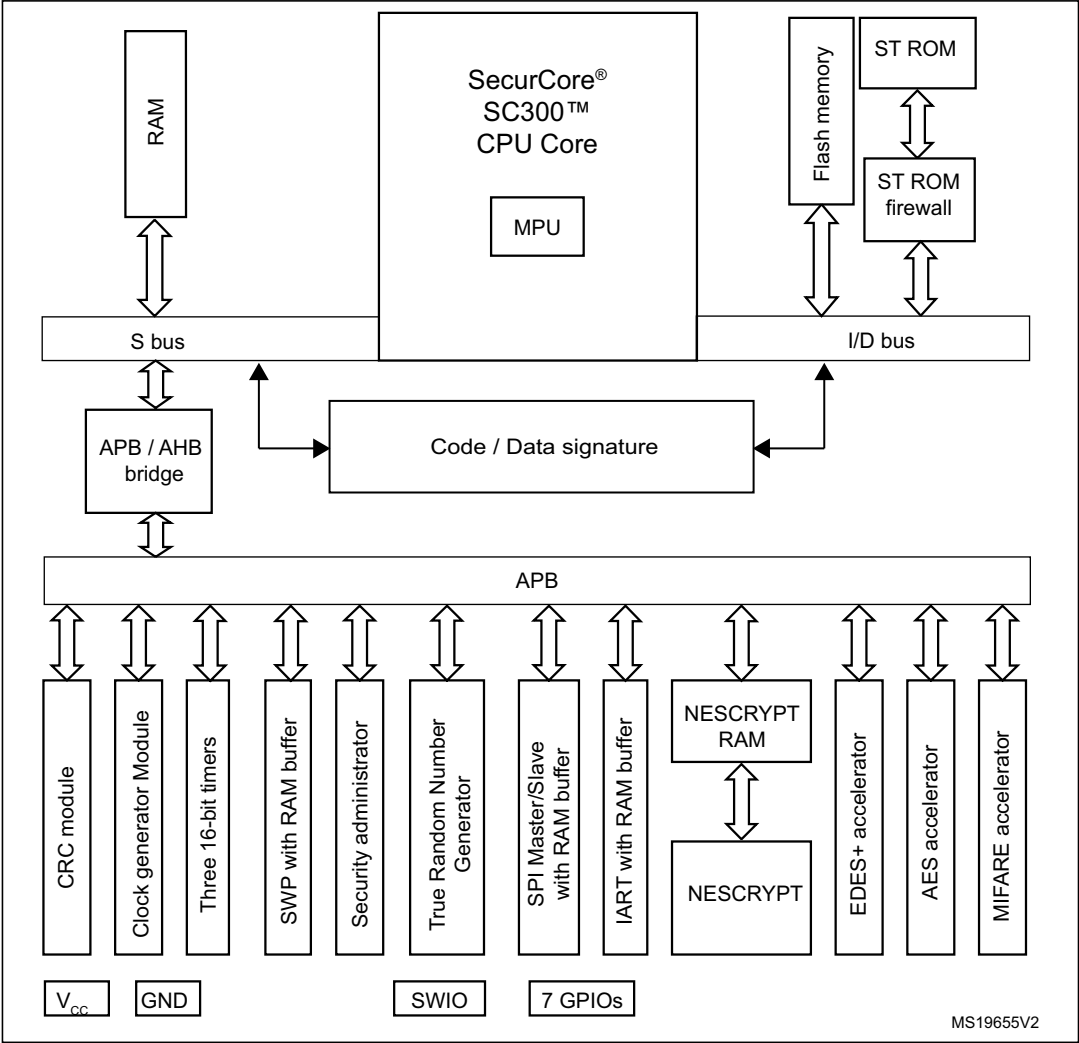
The device features hardware accelerators for advanced cryptographic functions. The EDES peripheral provides a secure DES (Data Encryption Standard) algorithm implementation, while the NESCRIPT cryptoprocessor efficiently supports the public key algorithm. The AES peripheral ensures secure and fast AES algorithm implementation.

The device operates in the –25 to +85 °C temperature range and 1.8 V, 3 V and 5 V supply voltage ranges. A comprehensive range of power-saving modes enables the design of efficient low-power applications.

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.



Figure 1. Block diagram



2 Software development tool description

Dedicated SecurCore® SC300™ software development tools are provided by ARM and Keil®. This includes the Instruction Set Simulator (ISS) and C compiler. The documentation is available on the ARM and Keil websites.

Moreover, STMicroelectronics provides:

- A time-accurate hardware emulator controlled by the Keil debugger and the STMicroelectronics development environment.
- A complete product simulator based on Keil's ISS simulator for the SecurCore® SC300™ CPU.
- A secured ROMed Flash memory loader with very high-speed software downloading capabilities.

3 Ordering information

Example:

ST33 G 1M2 PP FN A ABC

Platform name

ST33: ARM® SecurCore® SC300™ 32-bit RISC core

Product family

G: 25 MHz core frequency

NVM size

1M2 = 1280 Kbytes

1M0 = 1024 Kbytes

...

384 = 384 Kbytes

Hardware and software options

PP

Package codification

L8 = WLCSP

DN = UFDFN8 4.2 × 4 mm

FN = DFN8 6 × 5 mm

54 = Sawn wafer

ON = Unsawn wafer

18 = D18 micromodule

External hardware revision

A

Chameleon code

ABC = External firmware revision and customer identification

Note:

Not all combinations are necessarily available. For a list of available options (speed, package, etc.) or for further information on any aspect of this device, please contact your nearest STMicroelectronics sales office.

For information about Common Criteria certified product revisions, please refer to the public Security Target document.

4 Revision history

Table 1. Document revision history

Date	Revision	Changes
01-Oct-2013	1	Initial release.
20-Jun-2014	2	Added derivative devices.
18-Feb-2016	3	Added ST33lxxx products (see Table 1: Device summary). Indicated the ECOPACK® compliance of packages.
04-May-2016	4	Added product delivery forms on cover page. Added Figure 1: Block diagram . Added Section 3: Ordering information . Small text changes.
19-May-2016	5	Removed ST33lxxx products.

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